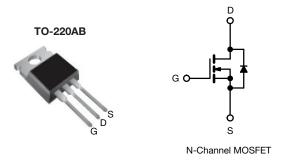
SiHP065N60E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	650					
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.057				
Q _g max. (nC)	74					
Q _{gs} (nC)	19					
Q _{gd} (nC)	15					
Configuration	Single					

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (C_{o(er)})
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Load (Ph) free and helegen free	SiHP065N60E-BE3 ^a
Lead (Pb)-free and halogen-free	SiHP065N60E-GE3

Note

a. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	600	v
Gate-source voltage	V _{GS}	± 30	V		
Continuous drain current (T _J = 150 °C)	V at 10 V	T_{GS} at 10 V $\frac{T_C = 25 °C}{T_C = 100 °C}$	- I _D -	40	
	V _{GS} at 10 V	T _C = 100 °C		25	А
Pulsed drain current ^a			I _{DM}	116	
Linear derating factor				2.0	W/°C
Single pulse avalanche energy ^b			E _{AS}	226	mJ
Maximum power dissipation			P _D	250	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T _J = 125 °C			100	
Reverse diode dV/dt ^d			dV/dt	50	V/ns
Soldering recommendations (peak temperature) ^c	For	10 s		300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 4.0 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dl/dt = 400 A/µs, starting T_J = 25 °C

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HALOGEN

FREE



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THERMAL RESISTANCE RAT	INGS						
PARAMETER	SYMBOL	TYP. MAX.			UNIT		
Maximum junction-to-ambient	R _{thJA}	- 62			00 AN		
Maximum junction-to-case (drain)	R _{thJC}	- 0.5			°C/W		
SPECIFICATIONS (T _J = 25 °C,	uplace otherwi	so noted)					
PARAMETER $(1) = 23 \circ 0$,	SYMBOL	se noted) TEST CONDITIONS MIN.		TYP.	MAX.	UNI	
Static	•	-		•			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, $I_D = 1 \text{ mA}$			0.72	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		3	-	5	V
	1	V _{GS} =	± 20 V	-	-	°C/W 'YP. MAX. 0.72 - - 5 - ±100 - ±1 - 10 .057 0.065 12 - 700 -	nA
Gate-source leakage	I _{GSS}	V _{GS} = ± 30 V		-	-	± 1	μA
		$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	μA
Zero gate voltage drain current	IDSS	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$		-	-	10	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 16 A	-	0.057	0.065	Ω
Forward transconductance	9 _{fs}	V _{DS} = 20 V	/, I _D = 16 A	-	12	-	S
Dynamic	-						
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2700	-	
Output capacitance	C _{oss}			-	102	-	
Reverse transfer capacitance	C _{rss}			-	5	-	
Effective output capacitance, energy	_						pF

Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	93	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	593	-	
Total gate charge	Qg			-	49	74	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 16 \text{ A}, V_{DS} = 480 \text{ V}$	-	19	-	nC
Gate-drain charge	Q _{gd}			-	15	-	
Turn-on delay time	t _{d(on)}			-	28	56	
Rise time	t _r		V _{DD} = 480 V, I _D = 16 A,		46	92	ns
Turn-off delay time	t _{d(off)}	V_{GS} = 10 V, R_g = 9.1 Ω		-	54	108	
Fall time	t _f			-	13	26	
Gate input resistance	R _g	f = 1 MHz, open drain		0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	40	А
Pulsed diode forward current	I _{SM}			-	-	116	
Diode forward voltage	V _{SD}	T _J = 25 °C	$T_J = 25 \text{ °C}, I_S = 16 \text{ A}, V_{GS} = 0 \text{ V}$		-	1.2	V
Reverse recovery time	t _{rr}			-	382	764	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \ ^{\circ}C, I_F = I_S = 16 \ A,$ dI/dt = 100 A/µs, V _R = 400 V		-	7.1	14.2	μC
Reverse recovery current	I _{RRM}			-	34	-	Α

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS





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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

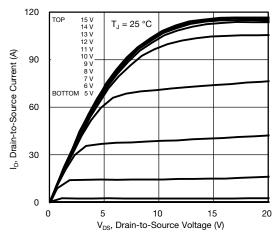
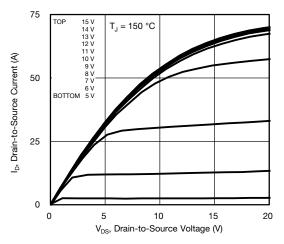


Fig. 1 - Typical Output Characteristics





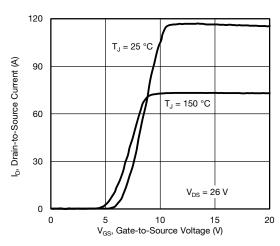


Fig. 3 - Typical Transfer Characteristics

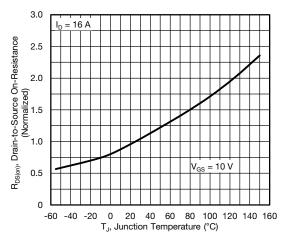


Fig. 4 - Normalized On-Resistance vs. Temperature

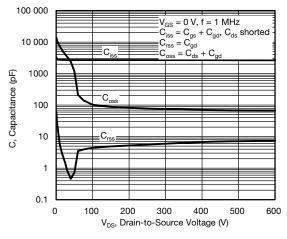


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

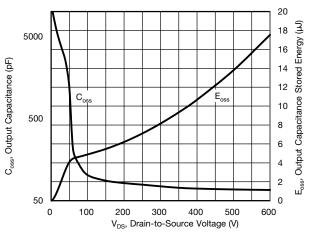


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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3 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91938

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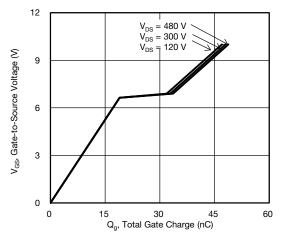


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

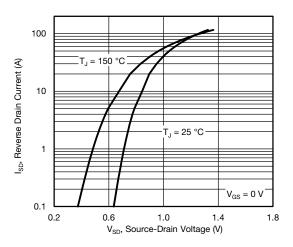


Fig. 8 - Typical Source-Drain Diode Forward Voltage

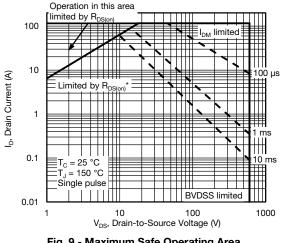


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

4

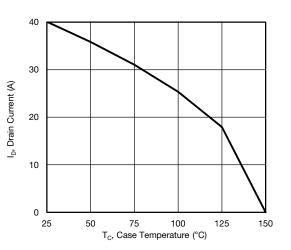


Fig. 10 - Maximum Drain Current vs. Case Temperature

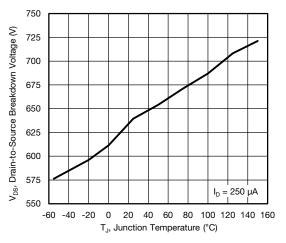
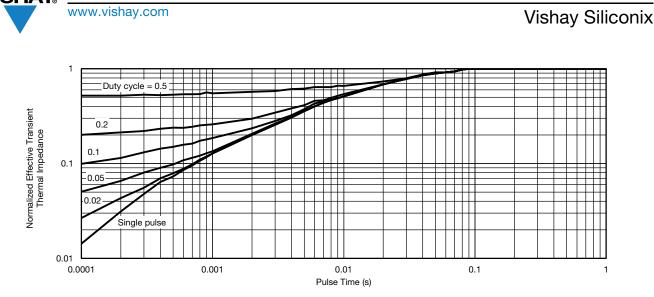


Fig. 11 - Temperature vs. Drain-to-Source Voltage





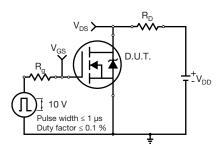


Fig. 13 - Switching Time Test Circuit

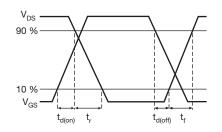


Fig. 14 - Switching Time Waveforms

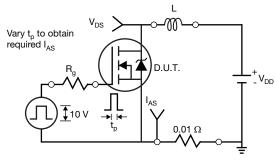


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

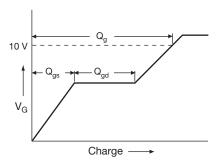


Fig. 17 - Basic Gate Charge Waveform

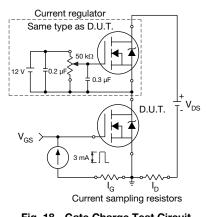
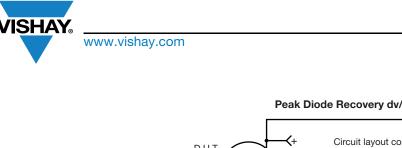


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

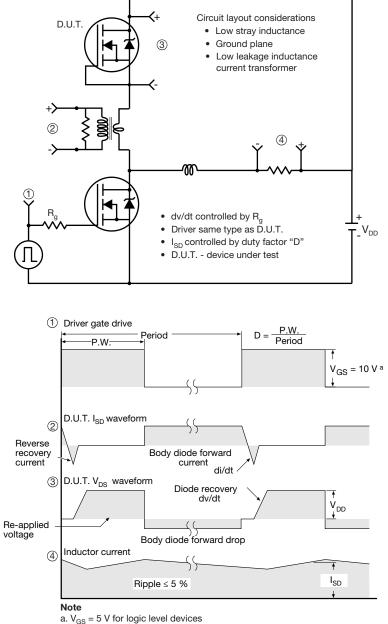


Fig. 19 - For N-Channel

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